

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hee-Jeong CHO</td> <td>02/09/2010</td> </tr> <tr> <td>Ki-Seon RYU</td> <td>02/09/2010</td> </tr> <tr> <td>Doo-Hyun SUNG</td> <td>02/09/2010</td> </tr> <tr> <td>Ae-Ran YOUN</td> <td>02/09/2010</td> </tr> <tr> <td>Yong-Ho KIM</td> <td>02/09/2010</td> </tr> <tr> <td>Young-Soo YUK</td> <td>02/09/2010</td> </tr> </tbody> </table>		Name	Execution Date	Hee-Jeong CHO	02/09/2010	Ki-Seon RYU	02/09/2010	Doo-Hyun SUNG	02/09/2010	Ae-Ran YOUN	02/09/2010	Yong-Ho KIM	02/09/2010	Young-Soo YUK	02/09/2010
Name	Execution Date														
Hee-Jeong CHO	02/09/2010														
Ki-Seon RYU	02/09/2010														
Doo-Hyun SUNG	02/09/2010														
Ae-Ran YOUN	02/09/2010														
Yong-Ho KIM	02/09/2010														
Young-Soo YUK	02/09/2010														
RECEIVING PARTY DATA															
<table border="1"> <tr> <td>Name:</td> <td>LG ELECTRONICS INC.</td> </tr> <tr> <td>Street Address:</td> <td>20 Yeouido-dong, Yeongdeungpo-gu</td> </tr> <tr> <td>City:</td> <td>Seoul</td> </tr> <tr> <td>State/Country:</td> <td>KOREA, REPUBLIC OF</td> </tr> <tr> <td>Postal Code:</td> <td>150-721</td> </tr> </table>		Name:	LG ELECTRONICS INC.	Street Address:	20 Yeouido-dong, Yeongdeungpo-gu	City:	Seoul	State/Country:	KOREA, REPUBLIC OF	Postal Code:	150-721				
Name:	LG ELECTRONICS INC.														
Street Address:	20 Yeouido-dong, Yeongdeungpo-gu														
City:	Seoul														
State/Country:	KOREA, REPUBLIC OF														
Postal Code:	150-721														
PROPERTY NUMBERS Total: 1															
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13564171</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13564171										
Property Type	Number														
Application Number:	13564171														
CORRESPONDENCE DATA															
Fax Number:	2136232211														
Phone:	213-623-2221														
Email:	patent@lhlaw.com														
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>															
Correspondent Name:	LEE, HONG, DEGERMAN, KANG & WAIMEY														
Address Line 1:	660 S. FIGUEROA STREET														
Address Line 2:	Suite 2300														
Address Line 4:	LOS ANGELES, CALIFORNIA 90017														
ATTORNEY DOCKET NUMBER:	2101-3773C1														

OP \$40.00 13564171

NAME OF SUBMITTER:

David G. Majdali

Total Attachments: 2

source=7_2101-3773C1_Parent_Assignment#page1.tif

source=7_2101-3773C1_Parent_Assignment#page2.tif

ASSIGNMENT

- (1-8) Insert Name(s) of Inventor(s)
- | | |
|-------------------|-------------------|
| (1) Hae-Jeong CHO | (5) Yong-Ho KIM |
| (2) Ki-Seon RYU | (6) Young-Soo YUK |
| (3) Doo-Hyun SUNG | (7) |
| (4) Ae-Ran YOUN | (8) |

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

- (9) Insert name of Assignee (9) LG ELECTRONICS INC.
(10) Insert state of Incorporation of Assignee (10) Republic of Korea
(11) Insert address of Assignee (11) 20, Yeouido-Dong, Yeongdeungpo-Gu, Seoul, Korea

(hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as:

- (12) Insert identification of Invention, such as Title, Case Number or Foreign Application Number (12) **METHOD AND APPARATUS FOR UPDATING SYSTEM INFORMATION IN BROADBAND WIRELESS COMMUNICATION SYSTEM**

for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding thereto or based thereon.

- (13) Insert Date of Signing of Application (13) Feb. 9, 2010

1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

The undersigned hereby appoints the ATTORNEYS ASSOCIATED WITH CUSTOMER NO. 035884 the power to insert on this assignment any further identification which may be necessary or desirable in order to

comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: <u>Feb. 09. 2010</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>Feb. 09. 2010</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>Feb. 09. 2010</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>Feb. 09. 2010</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>Feb. 09. 2010</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>Feb. 09. 2010</u>	Signature of Inventor <u>[Signature]</u>